

# STS17NF3LL

# N-channel 30V - $0.0045\Omega$ - 17A - SO-8 STripFET<sup>TM</sup> II Power MOSFET for DC-DC conversion

### **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STS17NF3LL	30V	<0.0055Ω	17A

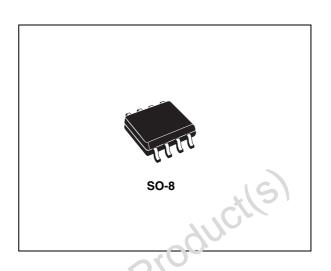
- lacktriangle Optimal  $R_{DS(on)}$  x  $Q_g$  trade-off @ 4.5V
- Conduction losses reduced
- Switching losses reduced

### **Description**

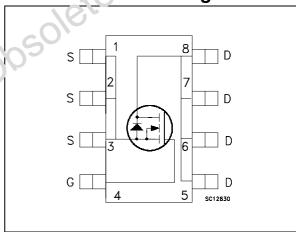
This application specific Power MOSFET is the second generation of STMicroelectronis unique "Single Feature Size™" strip-based process. The resulting transistor shows the best trade-off between on-resistance and gate charge. Such features make it the best choice in high efficiency DC-DC converters for Telecom and computer industries.

# **Applications**

■ Switching application



### Internal schematic diagram



### Cruer codes

1	Part number	Marking	Package	Packaging
	STS17NF3LL	S17NF3LL	SO-8	Tape & reel

Contents STS17NF3LL

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STS17NF3LL **Electrical ratings** 

#### **Electrical ratings** 1

Table 1. **Absolute maximum ratings** 

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	30	V
V <sub>GS</sub>	Gate-source voltage	±18	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25°C	17	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100°C	12	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	68	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	3.2	W

<sup>1.</sup> Pulse width limited by safe operating area

Table 2. Thermal data

Rthj-amb	Thermal resistance junction-ambient max (1)	47	°C/W			
Rthj-lead	Thermal resistance junction-leads max	16	°C/W			
T <sub>j</sub>	Maximum operating junction temperature	-55 to 175	°C			
T <sub>stg</sub>	Storage temperature	-55 to175	°C			
1. When mounted on FR-4 board of 1in², 2oz Cu. t<10sec						

**Electrical characteristics** STS17NF3LL

#### **Electrical characteristics** 2

(T<sub>CASE</sub>=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> =0 30				V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = max rating $V_{DS}$ =max rating, $T_{C}$ = 125°C			1 10	μA μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 18V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 10V, I_D = 8.5A$ $V_{GS} = 4.5V, I_D = 8.5A$		0.0045 0.0055	0.0055 0.007	Ω Ω
Table 4.	Dynamic			OQ/	,	
Symbol	Parameter	Test conditions	Min.	Typ	Max	Unit

Table 4. **Dynamic** 

	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	g <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	$V_{DS} = 10V, I_{D} = 8.5A$		37		S
	C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V, f = 1MHz, V_{GS} = 0$		2160 614 98		pF pF pF
	t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ = 15V, $I_D$ = 8.5A $R_G$ = 4.7 $\Omega$ $V_{GS}$ = 4.5V (see <i>Figure 13</i> )		23.5 39 47.5 37		ns ns ns
	Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ = 24V, $I_D$ = 12.5A, $V_{GS}$ = 4.5V, $R_G$ = 4.7 $\Omega$ (see <i>Figure 14</i> )		26 7 12	35	nC nC nC
Obsole	1. Pulsed: P	ulse duration = 300 μs, duty cy	cle 1.5 %.				

Table 5. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)				17 68	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 17A, V <sub>GS</sub> = 0			1.2	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 17A$ , di/dt = 100A/ $\mu$ s, $V_{DD} = 15V$ ; $T_{j} = 150$ °C (see <i>Figure 15</i> )		39 45 2.3		ns nC A

- 1. Pulse width limited by safe operating area.
- 2. Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5 % Obsolete Product(s).

Electrical characteristics STS17NF3LL

# 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

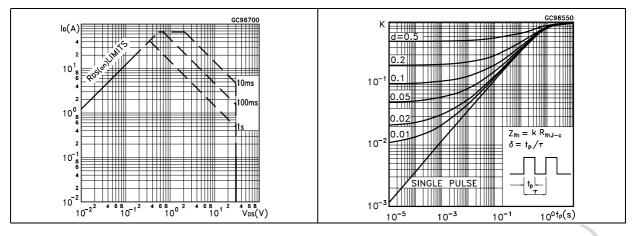


Figure 3. Output characterisics

Figure 4. Transfer characteristics

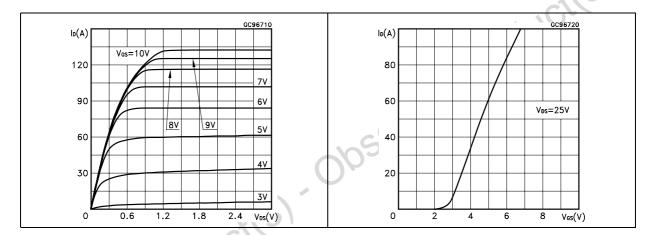


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

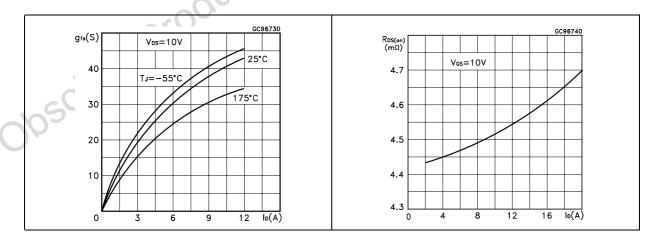


Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

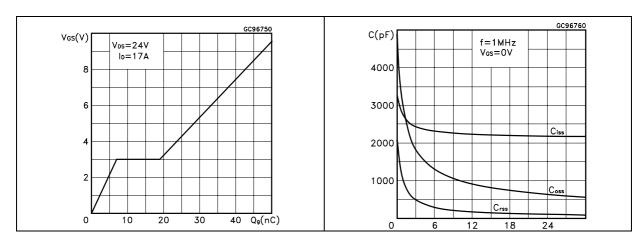


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

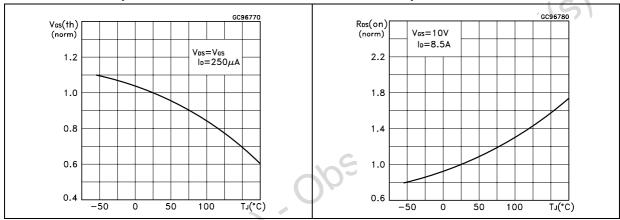
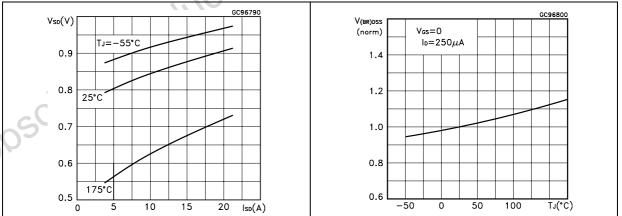


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized breakdown voltage vs temperature



Test circuit STS17NF3LL

# 3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

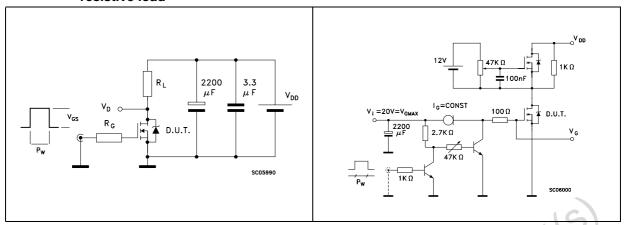


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

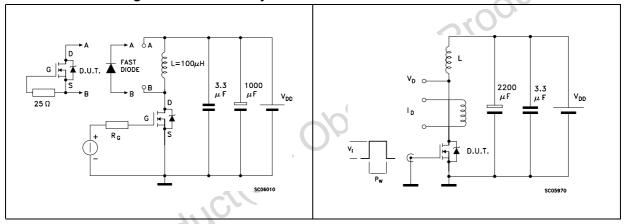
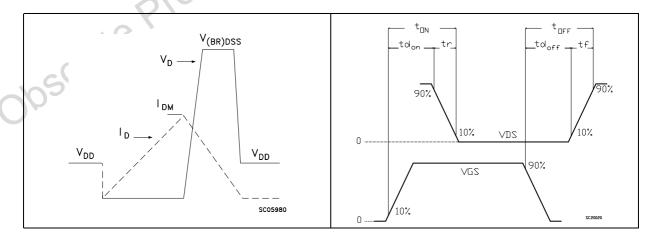


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



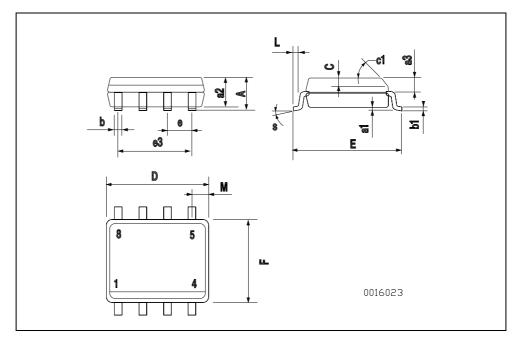
# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s). Obsolete Product(s)

### **SO-8 MECHANICAL DATA**

DIM		mm.				
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1		45 (typ.)				
D	4.8		5.0	0.188	0.196	
Е	5.8		6.2	0.228	0.244	
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S		•	8 (r	nax.)	•	•



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**5**//

STS17NF3LL Revision history

# 5 Revision history

Table 6. Revision history

Date	Revision	Changes
21-Jun-2004	4	Complete document
04-Oct-2006	5	New template, no content change

Obsolete Product(s). Obsolete Product(s)

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